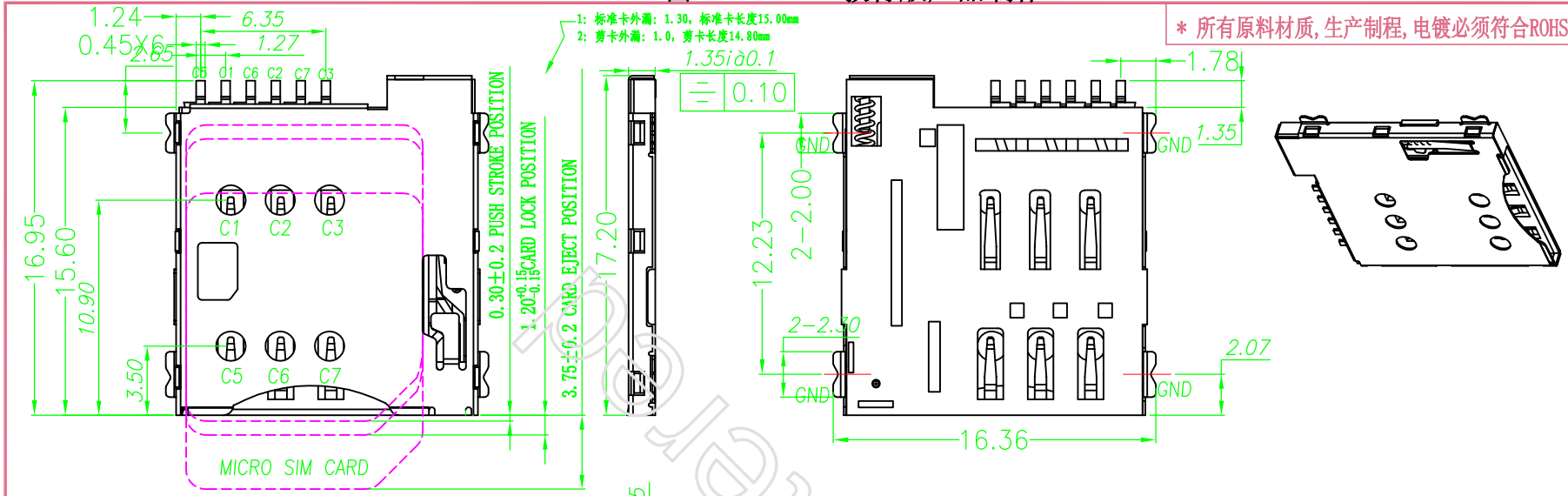
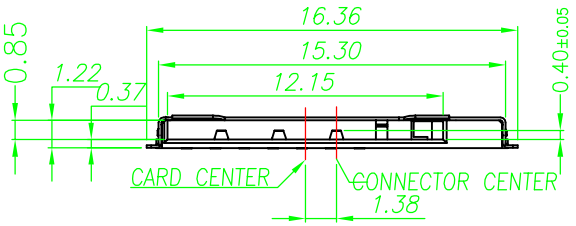
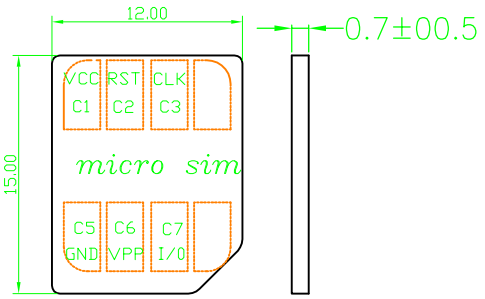
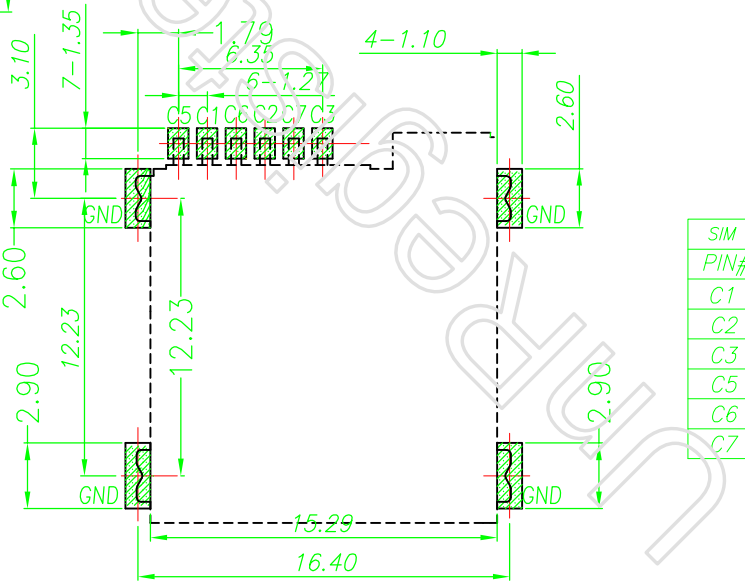
由 Autodesk 教育版产品制作







MICRO SIM CARD



SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出

Specification

MATERIAL:
- Insulator: High Temperature Thermoplastic, UL 94V-0.
- Contact: Copper Alloy
- SHELL: SUS

PLATING:
- Contact: Plated 50u'' Ni Overall Contact Au 1U
- Shell: Plated 50u'' Ni Overall
- Plated 1u"Au Selective Contact Area

Electrical:
- Current Rating :0.5mA AC/DC max.
- Voltage Rating :125V AC/DC
- Ambient Temperature Range :-20° C~+60° C
- Storage Temperature Range :-40° C~+70° C
- Ambient Humidity Range :95% R.H. Max.
- Contact Resistance:100m max. Ω
- Insulation Resistance:1000M min./500VDCΩ
- 产品耐温温度: 260° C $\frac{C\,5\%1.7\%2-C\,5\%1.7\%2\pm5\ C}{5\ C}$
- Mating Cycles:3000Min Insertions

* 所有原料材质,生产制程,电镀必须符合ROHS要求

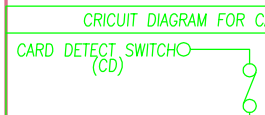
PCB 焊盘区

下沉避位区

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

CRICUIT DIAGRAM FOR CARD DETECT SWITCH



REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
X.X: ±	0.15
X.XX: ±	0.10
X.XXX: ±	0.05
ANGULAR: ±	1°

深圳市鑫南天科技有限公司
Shen zhen Shi Xin Nan Tian Industrial Co., Ltd

PRODUCT NAME : MICRO-SIM 卡座PUSH/PUSH 1.35H 6P	DRAWING: COCO	DATE: 2015/10/10
PRODUCT NO. : XNT-0121AAAA07A	CHECK: JANY	DATE: 2015/11/11
DRAWING NO. : XNT-0012	APPROVED: 林心祥	DATE: 2015/11/11
	SCALE: 1:1	DWG ID: C D / REV.: B / PAGE: 1 OF 1

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